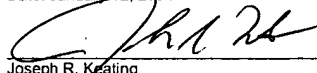


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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to the: Assistant Commissioner for Patents, Washington, D. C. 20231.

Date: January 12, 2004


Joseph R. Keating

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OFFICE OF PETITIONS
PATENT
60303.10

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kenichi FUNAMOTO et al.

Serial No.: 09/395,179

Filed: September 19, 1999

Title: PACKAGE FOR ELECTRONIC
COMPONENT, LID MATERIAL FOR
PACKAGE LID, AND PRODUCTION
METHOD FOR LID MATERIAL

Art Unit: 1775

Examiner: M. Lavilla

AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated July 16, 2002, please amend the above-identified application as follows:

- ☐ **Amendments to the Specification** begin on page of this paper.
- ☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page 2 of this paper.
- ☐ **Amendments to the Drawings** begin on page of this paper.
- ☒ **Remarks/Arguments** begin on page 5 of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.